## THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	§	Patent No.:	6998952 B2
ZHOU, YAPING, et al.	<b>\$</b>	Issue Date:	02-14-2006
Application No.: 10/729531	§		
Filed: 12-05-2003	<b>9</b>	Examiner:	Anh Mai
	9	Group Art Unit: 2832	
Docket No.: SC12717TK	§		

Title: INDUCTIVE DEVICE INCLUDING BOND WIRES

## Certificate of Submission

	I hereby certify that this correspondence is being submitted to the USPTO,		
Ale	randria, VA.		
	Addressed per C.F.R. § 1.1(a) and deposited with the United States Postal Service with sufficient postage as first class mail.		
	Facsimile transmitted in accordance with C.F.R. §1.6(d).		
Ø	Submitted electronically via EFS in accordance with "Legal Framework for EFS Web".		
	May 30, 2008		
	e of Submission  Lisean Shapshard		
Sign	nature 3		
	Teresa Shephard		

Printed Name of Person Signing Certificate

Commissioner for Patents Alexandria, VA 22313

## SUBMISSION OF CERTIFICATE OF CORRECTION

Dear Commissioner:

Enclosed is a Certificate of Correction listing error(s) in the subject patent.

Please enter these corrections. Since the errors appear to be on the part of the United States Patent Office, there should be no charge.

Respectfully submitted,

SINGH, RANJEEV

Attorney for Applicant(s) Registration No. 47093

Telephone No. (512) 996-6839 Facsimile No. (512) 996-6854

PTO/SB/ 44 (04-05)
Approved for use through 04/30/2007 OMB 0651-0033
Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

(Also Form PTO-1050)

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION				
02.	Page _ 1 _ of _ 1 _			
PATENT NO.:	6998952 B2			
APPLICATION NO:	10/729531			
DATE:	12-05-2003			
FIRST NAMED INVENTOR:	ZHOU, YAPING			
It is certified that error appears in the above-identified patent and that said Letters  Patent are hereby corrected as shown below:				
In Column 5, Line 25, Claim No. 1:  Change "plurality of bond wires extending over due core" toplurality of bond wires extending over the core				
In Column 6, Line 49, Claim No. 26:  Change "plurality or bond wires includes a conductive material" toplurality of bond wires includes a conductive material				
. 1				

MAILING ADDRESS OF SENDER (Please do not use customer number below)

Freescale Semiconductor, Inc. Law Department 7700 West Parmer Lane PL02 Austin, TX 78729